

# 74LVC16374A; 74LVCH16374A

16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Rev. 12 — 20 November 2018

Product data sheet

## 1. General description

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The 74LVC16374A and 74LVCH16374A are 16-bit edge-triggered flip-flops featuring separate D-type inputs with bus hold (74LVCH16374A only) for each flip-flop and 3-state outputs for bus-oriented applications. It consists of two sections of eight positive edge-triggered flip-flops. A clock input (nCP) and an output enable (nOE) are provided for each octal.

The flip-flops store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition.

When pin  $\overline{\text{nOE}}$  is LOW, the contents of the flip-flops are available at the outputs. When pin  $\overline{\text{nOE}}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of input  $\overline{\text{nOE}}$  does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

## 2. Features and benefits

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- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Low inductance multiple supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74LVCH16374A only)
- High-impedance outputs when  $V_{CC} = 0$  V
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

### 3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
74LVC16374ADL	-40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1
74LVC16374ADGG	-40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1
74LVCH16374ADGG				

### 4. Functional diagram

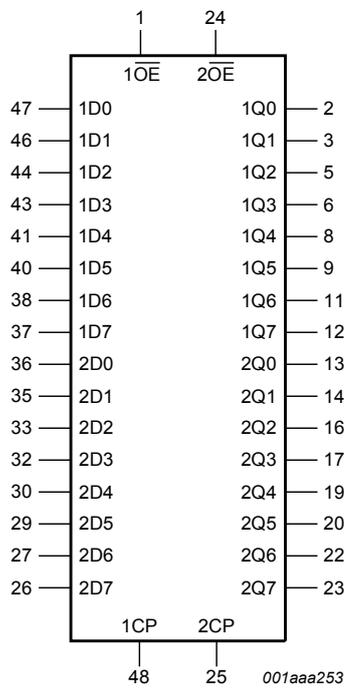


Fig. 1. Logic symbol

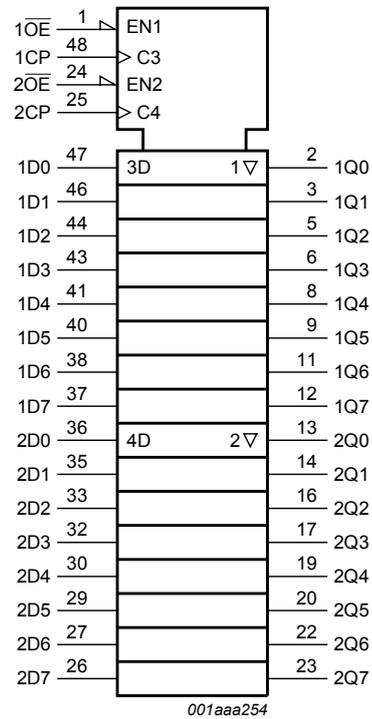


Fig. 2. IEC logic symbol

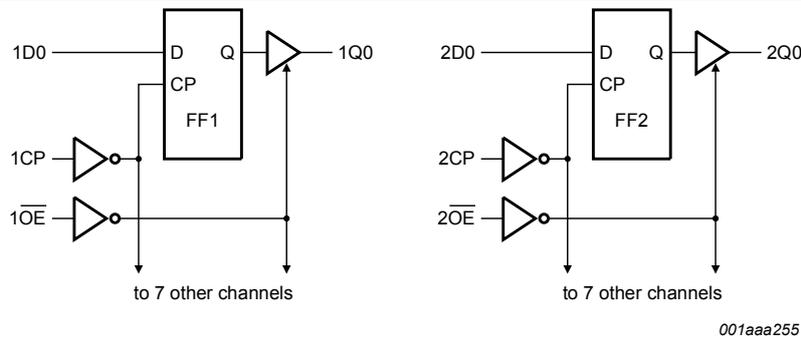


Fig. 3. Logic diagram

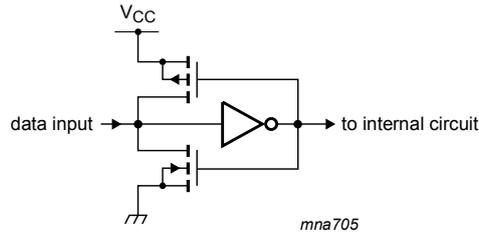


Fig. 4. Bus hold circuit

## 5. Pinning information

### 5.1. Pinning

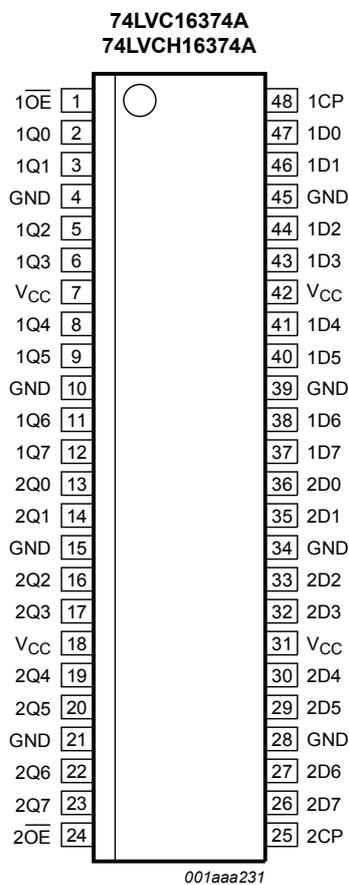


Fig. 5. Pin configuration SOT370-1 (SSOP48) and SOT362-1 (TSSOP48)

## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1OE, 2OE	1, 24	output enable input (active LOW)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V <sub>CC</sub>	7, 18, 31, 42	supply voltage
1Q0 to 1Q7	2, 3, 5, 6, 8, 9, 11, 12	data output
2Q0 to 2Q7	13, 14, 16, 17, 19, 20, 22, 23	data output
1D0 to 1D7	47, 46, 44, 43, 41, 40, 38, 37	data input
2D0 to 2D7	36, 35, 33, 32, 30, 29, 27, 26	data input
1CP, 2CP	48, 25	clock input

## 6. Functional description

Table 3. Function selection

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state; ↑ = LOW-to-HIGH transition;  
 h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition;  
 l = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition.

Operating mode	Input			Internal flip-flop	Output nQ0 to nQ7
	nOE	nCP	nDn		
Load and read register	L	↑	l	L	L
	L	↑	h	H	H
Load register and disable outputs	H	↑	l	L	Z
	H	↑	h	H	Z

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
V <sub>I</sub>	input voltage	[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V	-	±50	mA
V <sub>O</sub>	output voltage	output HIGH-or LOW-state [2]	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state [2]	-0.5	+6.5	V
I <sub>O</sub>	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C [3]	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For (T)SSOP48 packages: above 60 °C, the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V <sub>I</sub>	input voltage		0	-	5.5	V
V <sub>O</sub>	output voltage	active mode	0	-	V <sub>CC</sub>	V
		power-down mode; V <sub>CC</sub> = 0 V	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V	0	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

## 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65xV <sub>CC</sub>	-	-	0.65xV <sub>CC</sub>	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35xV <sub>CC</sub>	-	0.35xV <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>						
		I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V <sub>CC</sub> - 0.3	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	-	-	1.05	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V	1.8	-	-	1.65	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	2.2	-	-	2.05	-	V
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V	2.4	-	-	2.25	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>						
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	0	0.2	-	0.3	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.65	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.6	-	0.8	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	-	0.6	V
I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	-	0.8	V		
I <sub>I</sub>	input leakage current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND[2]	-	±0.1	±5	-	±20	μA
I <sub>OZ</sub>	OFF-state output current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>O</sub> = 5.5 V or GND[2]	-	±0.1	±5	-	±20	μA

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$I_{OFF}$	power-off leakage current	$V_{CC} = 0\text{ V}$ ; $V_I$ or $V_O = 5.5\text{ V}$	-	$\pm 0.1$	$\pm 10$	-	$\pm 20$	$\mu\text{A}$
$I_{CC}$	supply current	$V_{CC} = 3.6\text{ V}$ ; $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$	-	0.1	20	-	80	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$ ; $V_I = V_{CC} - 0.6\text{ V}$ ; $I_O = 0\text{ A}$	-	5	500	-	5000	$\mu\text{A}$
$C_I$	input capacitance	$V_{CC} = 0\text{ V}$ to $3.6\text{ V}$ ; $V_I = \text{GND}$ to $V_{CC}$	-	5.0	-	-	-	pF
$I_{BHL}$	bus hold LOW current	$V_{CC} = 1.65\text{ V}$ ; $V_I = 0.58\text{ V}$ [3][4]	10	-	-	10	-	$\mu\text{A}$
		$V_{CC} = 2.3\text{ V}$ ; $V_I = 0.7\text{ V}$	30	-	-	25	-	$\mu\text{A}$
		$V_{CC} = 3.0\text{ V}$ ; $V_I = 0.8\text{ V}$	75	-	-	60	-	$\mu\text{A}$
$I_{BHH}$	bus hold HIGH current	$V_{CC} = 1.65\text{ V}$ ; $V_I = 1.07\text{ V}$ [3][4]	-10	-	-	-10	-	$\mu\text{A}$
		$V_{CC} = 2.3\text{ V}$ ; $V_I = 1.7\text{ V}$	-30	-	-	-25	-	$\mu\text{A}$
		$V_{CC} = 3.0\text{ V}$ ; $V_I = 2.0\text{ V}$	-75	-	-	-60	-	$\mu\text{A}$
$I_{BHLO}$	bus hold LOW overdrive current	$V_{CC} = 1.95\text{ V}$ [3][5]	200	-	-	200	-	$\mu\text{A}$
		$V_{CC} = 2.7\text{ V}$	300	-	-	300	-	$\mu\text{A}$
		$V_{CC} = 3.6\text{ V}$	500	-	-	500	-	$\mu\text{A}$
$I_{BHHO}$	bus hold HIGH overdrive current	$V_{CC} = 1.95\text{ V}$ [3][5]	-200	-	-	-200	-	$\mu\text{A}$
		$V_{CC} = 2.7\text{ V}$	-300	-	-	-300	-	$\mu\text{A}$
		$V_{CC} = 3.6\text{ V}$	-500	-	-	-500	-	$\mu\text{A}$

[1] All typical values are measured at  $V_{CC} = 3.3\text{ V}$  (unless stated otherwise) and  $T_{amb} = 25\text{ }^\circ\text{C}$ .

[2] The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input pin.

[3] Valid for data inputs (74LVCH16374A) only; control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data inputs holds the input below the specified  $V_I$  level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation delay	nCP to nQn; see Fig. 6 [2]						
		$V_{CC} = 1.2\text{ V}$	-	14	-	-	-	ns
		$V_{CC} = 1.65\text{ V}$ to $1.95\text{ V}$	2.1	6.9	13.5	2.1	15.6	ns
		$V_{CC} = 2.3\text{ V}$ to $2.7\text{ V}$	1.5	3.7	6.7	1.5	7.7	ns
		$V_{CC} = 2.7\text{ V}$	1.5	3.4	6.0	1.5	7.5	ns
$t_{en}$	enable time	$n\overline{OE}$ to nQn; see Fig. 7 [2]						
		$V_{CC} = 1.2\text{ V}$	-	20	-	-	-	ns
		$V_{CC} = 1.65\text{ V}$ to $1.95\text{ V}$	1.5	5.9	13.1	1.5	15.1	ns
		$V_{CC} = 2.3\text{ V}$ to $2.7\text{ V}$	1.5	3.4	6.9	1.5	8.0	ns
		$V_{CC} = 2.7\text{ V}$	1.5	3.6	6.0	1.5	7.5	ns
		$V_{CC} = 3.0\text{ V}$ to $3.6\text{ V}$	1.0	2.7	5.2	1.0	6.5	ns

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>dis</sub>	disable time	n $\overline{OE}$ to nQn; see Fig. 7 [2]						
		V <sub>CC</sub> = 1.2 V	-	12	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.8	4.6	9.1	2.8	10.5	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.5	4.9	1.0	5.7	ns
		V <sub>CC</sub> = 2.7 V	1.5	3.4	5.1	1.5	6.5	ns
t <sub>w</sub>	pulse width	nCP HIGH; see Fig. 6						
		V <sub>CC</sub> = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		V <sub>CC</sub> = 2.7 V	3.0	-	-	3.0	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.0	1.5	-	3.0	-	ns
t <sub>su</sub>	set-up time	nDn to nCP; see Fig. 8						
		V <sub>CC</sub> = 1.65 V to 1.95 V	4.0	-	-	4.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.0	-	-	3.0	-	ns
		V <sub>CC</sub> = 2.7 V	1.9	-	-	1.9	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.9	0.3	-	1.9	-	ns
t <sub>h</sub>	hold time	nDn to nCP; see Fig. 8						
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.0	-	-	3.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.5	-	-	2.5	-	ns
		V <sub>CC</sub> = 2.7 V	1.1	-	-	1.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	+1.5	-0.3	-	1.5	-	ns
f <sub>max</sub>	maximum frequency	see Fig. 6						
		V <sub>CC</sub> = 1.65 V to 1.95 V	100	-	-	80	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	125	-	-	100	-	ns
		V <sub>CC</sub> = 2.7 V	150	-	-	120	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	150	300	-	120	-	MHz
t <sub>sk(o)</sub>	output skew time	V <sub>CC</sub> = 3.0 V to 3.6 V [3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation capacitance	per input; V <sub>I</sub> = GND to V <sub>CC</sub> [4]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	14.1	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	16.4	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	18.5	-	-	-	pF

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>; t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

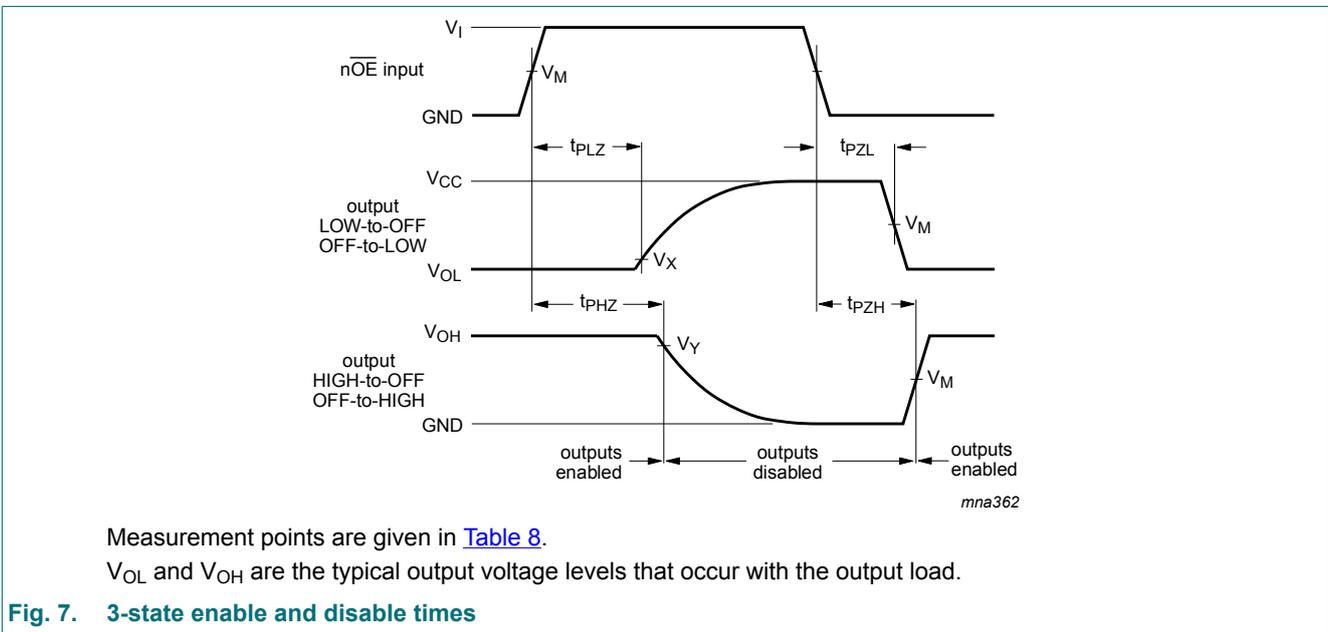
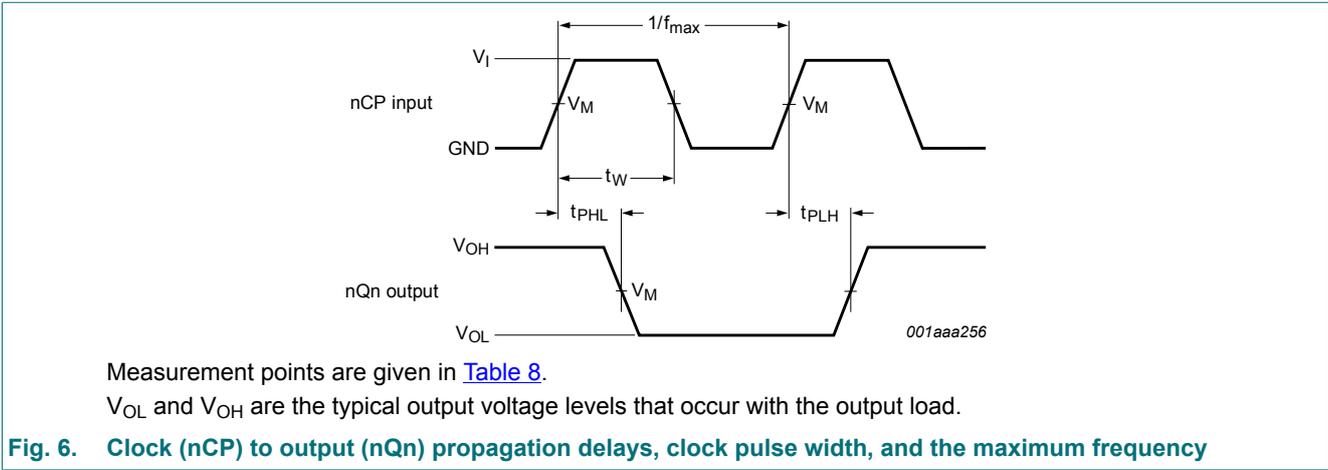
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

10.1. Waveforms and test circuit



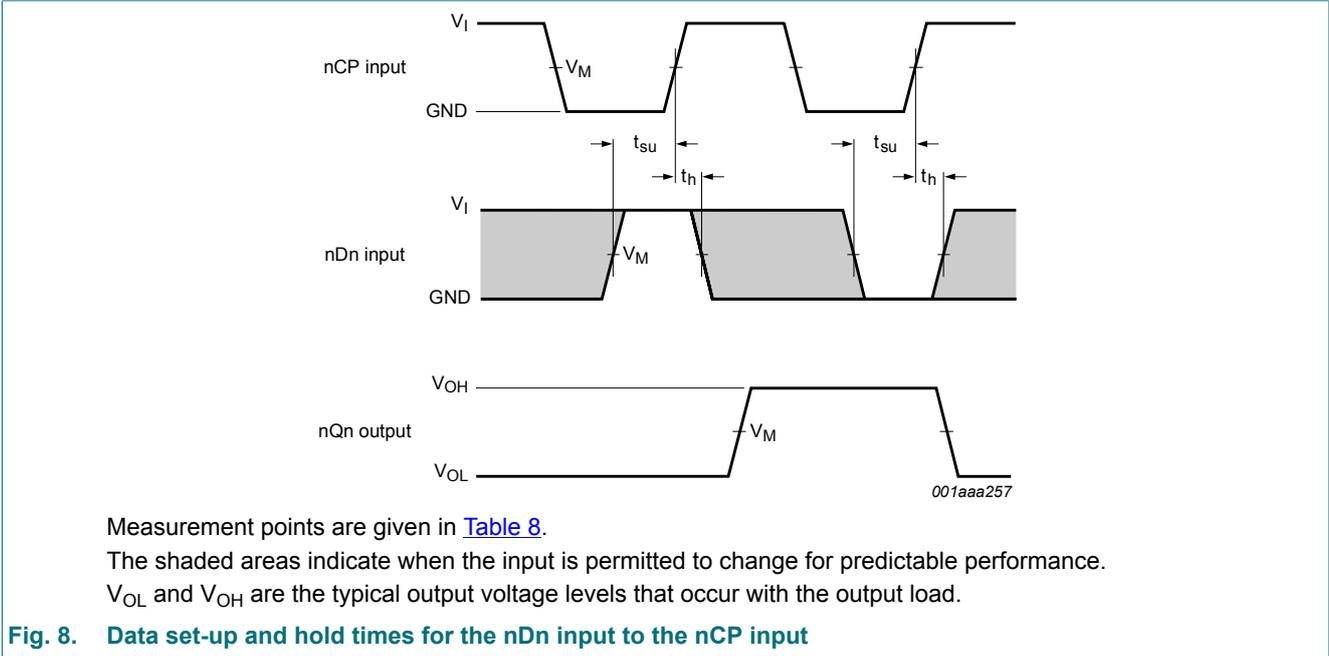
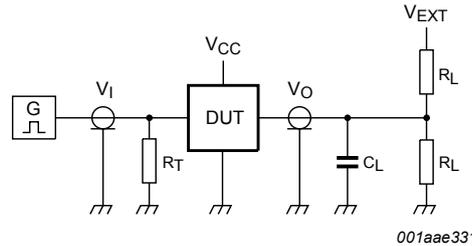
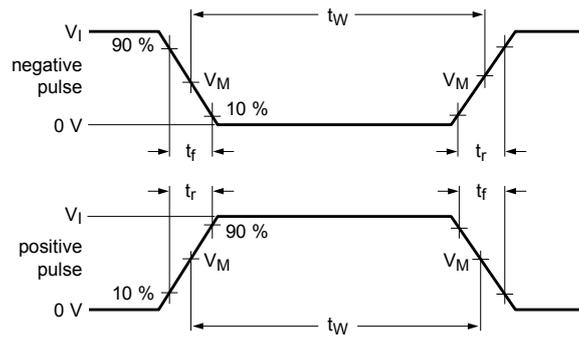


Table 8. Measurement points

Supply voltage	Input		Output		
$V_{CC}$	$V_I$	$V_M$	$V_M$	$V_X$	$V_Y$
1.2 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
1.65 V to 1.95 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
2.3 V to 2.7 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
2.7 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 \text{ V}$	$V_{OH} - 0.3 \text{ V}$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 \text{ V}$	$V_{OH} - 0.3 \text{ V}$



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Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig. 9. Test circuit for measuring switching times**

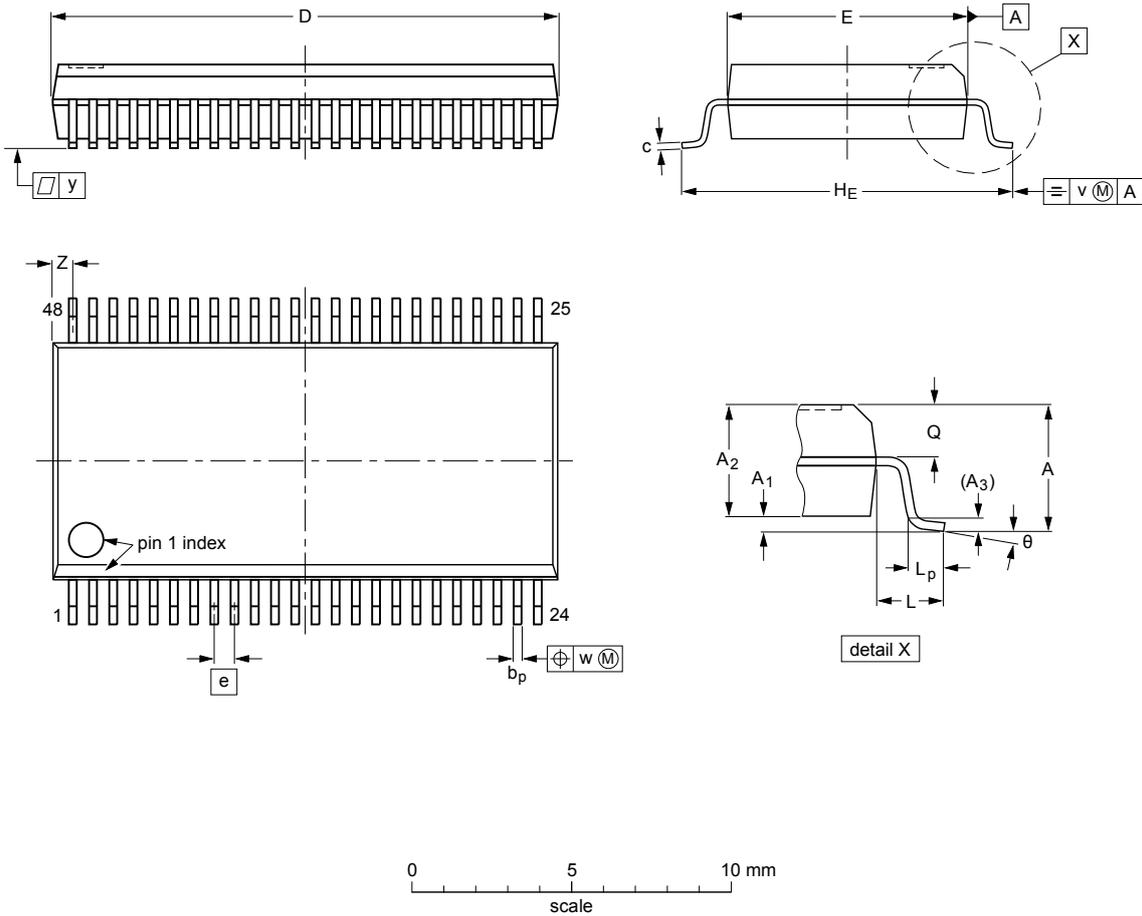
**Table 9. Test data**

Supply voltage	Input		Load		$V_{EXT}$		
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
1.2 V	$V_{CC}$	$\leq 2$ ns	30 pF	1 k $\Omega$	open	$2xV_{CC}$	GND
1.65 V to 1.95 V	$V_{CC}$	$\leq 2$ ns	30 pF	1 k $\Omega$	open	$2xV_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	$\leq 2$ ns	30 pF	500 $\Omega$	open	$2xV_{CC}$	GND
2.7 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2xV_{CC}$	GND
3.0 V to 3.6 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2xV_{CC}$	GND

11. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

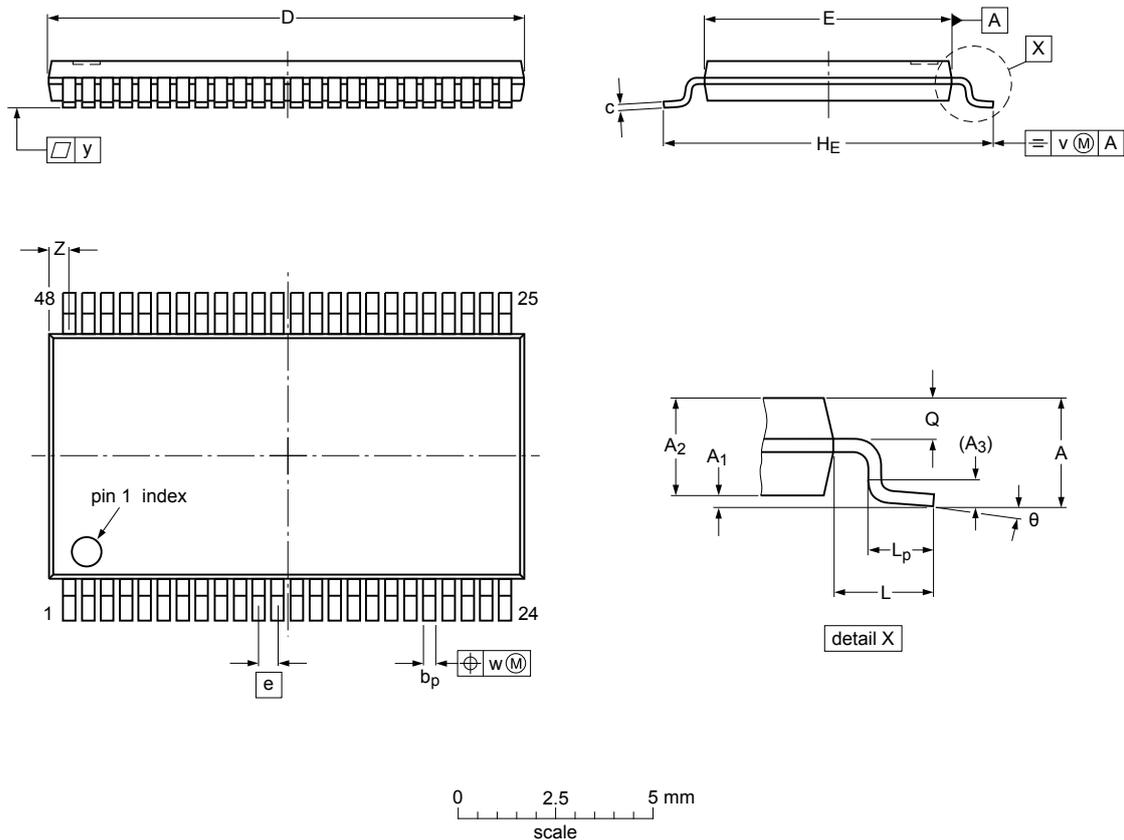
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT370-1		MO-118				99-12-27 03-02-19

Fig. 10. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



Dimensions (mm are the original dimensions)

Unit	A	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z	θ
max		0.15	1.05		0.28	0.2	12.6	6.2		8.3		0.8	0.50				0.8	8°
nom	1.2			0.25					0.5		1			0.25	0.08	0.1		
min		0.05	0.85		0.17	0.1	12.4	6.0		7.9		0.4	0.35				0.4	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

sot362-1\_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT362-1		MO-153				-03-02-19- 13-08-05

Fig. 11. Package outline SOT362-1 (TSSOP48)

## 12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16374A v.12	20181120	Product data sheet	-	74LVC_LVCH16374A v.11
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type numbers 74LVCH16374ADL (SOT370-1/SSOP48), 74LVC16374ABX and 74LVCH16374ABX (SOT1134-1/HXQFN60U) removed.</li> </ul>			
74LVC_LVCH16374A v.11	20130116	Product data sheet	-	74LVC_LVCH16374A v.10
Modifications:	<ul style="list-style-type: none"> <li>Minor non-technical text changes and corrections</li> <li>Document revision history correction</li> </ul>			
74LVC_LVCH16374A v.10	20120301	Product data sheet	-	74LVC_LVCH16374A v.9
74LVC_LVCH16374A v.9	20111219	Product data sheet	-	74LVC_LVCH16374A v.8
74LVC_LVCH16374A v.8	20110621	Product data sheet	-	74LVC_LVCH16374A v.7
74LVC_LVCH16374A v.7	20100323	Product data sheet	-	74LVC_LVCH16374A v.6
74LVC_LVCH16374A v.6	20090212	Product data sheet	-	74LVC_LVCH16374A v.5
74LVC_LVCH16374A v.5	20031212	Product specification	-	74LVC_H16374A v.4
74LVC_H16374A v.4	19980317	Product specification	-	74LVC16374A_74LVCH16374A v.3
74LVC16374A_74LVCH16374A v.3	19980317	Product specification	-	74LVC16374A v.2
74LVC16374A v.2	19970822	Product specification	-	74LVC16374A v.1
74LVC16374A v.1	-	-	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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